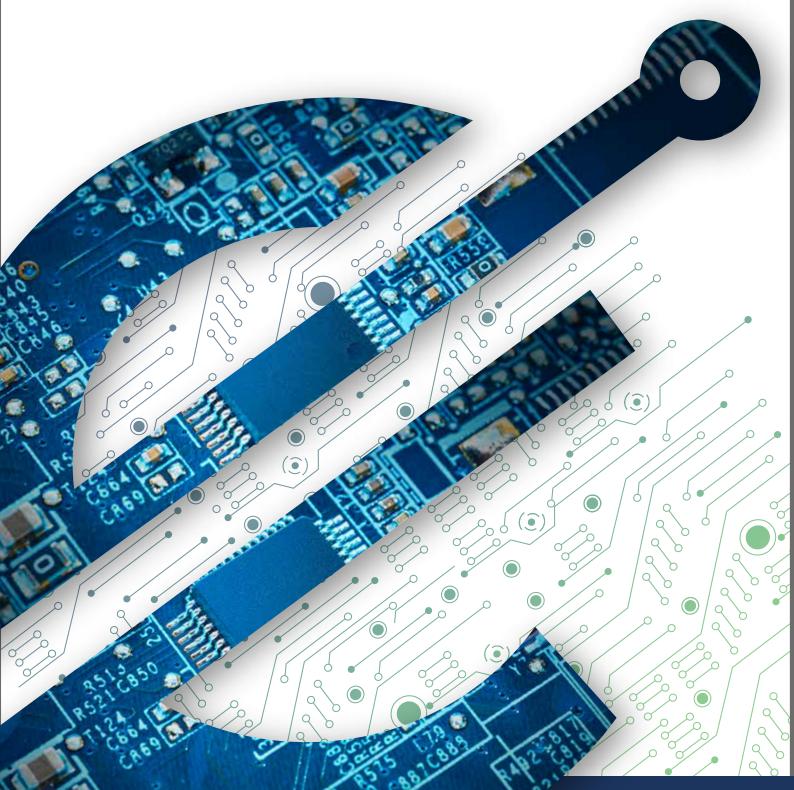


We Are Committed To Your Successes

www.nisteceltek.com



About

Eltek Global Sourcing has formed strategic partnerships with PCB suppliers around the world to provide an off-shore extension to our domestic manufacturing operations. Our ongoing goal is to assist our customers achieve the best possible time to market and competitive advantage by producing printed circuit boards in a sustainable way at the lowest total cost through our competence, delivery accuracy and product quality.

Eltek Global Sourcing with domestic engineering support; manufacturing infrastructure and domestic quality inspection, bringing you time to market savings. Working hand-in-hand with our domestic facilities, we can take you from prototype to mass volume production including inventory management; risk mitigation, all under the full support and backing of Eltek Ltd support.

Eltek Global Sourcing offer:

- High Density Rigid PCBs
- Flex &Rigid-Flex PCBs
- RF/Microwave PCBs

| STANDARD TECHNOLOGIES | Factory 1 | Factory 2 | Factory 3 |
|-------------------------------|-----------|-----------|-----------|
| Through-Hole Capabilities | | | |
| Rigid Layer Count | Yes | Yes | Yes |
| Standard 2 - 4 Layers | Yes | Yes | Yes |
| Standard 6 - 10 Layers | Yes | Yes | Yes |
| Advanced 10 - 20 Layers | Yes | Yes | Yes |
| Advanced 20 - 30+ Layers | Yes | Yes | Yes |
| Advanced Capabilities | | | |
| Flex | Yes | No | No |
| Rigid Flex | Yes | Yes | No |
| Cavity Boards | Yes | Yes | Yes |
| Sequential Lamination | Yes | Yes | Yes |
| Blind / Buried Via Capability | Yes | Yes | Yes |
| Via in Pad Capability | Yes | Yes | Yes |
| Any-Layer HDI | Yes | Yes | Yes |

| Through-Hole Capabilities | | | |
|-------------------------------|-----|-----|-----|
| Rigid Layer Count | Yes | Yes | Yes |
| Standard 2 - 4 Layers | Yes | Yes | Yes |
| Standard 6 - 10 Layers | Yes | Yes | Yes |
| Advanced 10 - 20 Layers | Yes | Yes | Yes |
| Advanced 20 - 30+ Layers | Yes | Yes | Yes |
| Advanced Capabilities | | | |
| Flex | Yes | No | No |
| Rigid Flex | Yes | Yes | No |
| Cavity Boards | Yes | Yes | Yes |
| Sequential Lamination | Yes | Yes | Yes |
| Blind / Buried Via Capability | Yes | Yes | Yes |
| Via in Pad Capability | Yes | Yes | Yes |
| Any-Layer HDI | Yes | Yes | Yes |
| | | | |

| MATERIALS | Factory 1 | Factory 2 | Factory 3 |
|--|-----------|-----------|-----------|
| CEM1 / CEM3 | No | Yes | No |
| Pb Free RoHs - 180 Tg FR4 | Yes | Yes | Yes |
| Pb Free / Halogen Free - Mid/High -Tg FR4 | Yes | Yes | Yes |
| Mid Loss - FR408 HR, -13EP | Yes | Yes | Yes |
| Low Loss - 13EPSI, I-Speed | Yes | Yes | Yes |
| Very Low Loss - | Yes | Yes | Yes |
| Ultra Low Loss - Meg 6, I-Tera | Yes | Yes | Yes |
| Polyimide Laminates | Yes | Yes | Yes |
| RF / Microwave / High Frequency | Yes | Yes | Yes |
| ВТ | No | Yes | No |
| Thermally Conductive Laminate / Prepreg | Yes | Yes | No |

Eltek Ltd.

HQ - Sales & Manufacturing

20 Ben Zion Gelis Street Petach Tikvah, 4927920

> +972 3 939 5050

main@nisteceltek.com

Eltek USA Inc.

Customer Service Sales & Technical support

) (480) 716-5421

✓ info@eltek.us

| SPECIAL TECHNOLOGIES | Factory 1 | Factory 2 | Factory 3 |
|--------------------------|-----------|-----------|-----------|
| Coin / Heat Sink | No | Yes | Yes |
| Al-backed | | No | No |
| Cu-Backed | No | Yes | Yes |
| Metal Core | No | Yes | Yes |
| Heavy Copper | Yes | Yes | Yes |
| Capacitive Laminate | No | No | No |
| Embedded Resistor Foil | No | No | No |
| Embedded Componenets | No | Yes | No |
| Conductive Paste | No | Yes | Yes |
| Substrate / IC Packaging | No | No | No |
| SAP / mSAP Process | No | No | No |
| Ceramic Packaging | No | No | No |
| | | | |

| | <u> </u> | | |
|--------------------------------|-----------|-----------|-----------|
| SURFACE FINISHES | Factory 1 | Factory 2 | Factory 3 |
| OSP | Yes | Yes | Yes |
| Electroless Nickel / Immersion | Gold Yes | Yes | Yes |
| ENEPIG | Yes | Yes | Yes |
| Hard Gold Body | No | Yes | Yes |
| Ni / Au Edge Fingers | Yes | Yes | Yes |
| Soft Gold | No | Yes | Yes |
| Immersion Silver | Yes | Yes | Yes |
| Immersion Tin | Yes | Yes | Yes |
| Lead Free HAL | Yes | Yes | Yes |
| Tin-Lead HAL | Yes | Yes | Yes |
| AS9100D | No | No | Yes |
| ISO 9001:2015 | Yes | Yes | Yes |
| ISO 14001:2015 | Yes | Yes | Yes |
| ISO 45001:2018 | No | Yes | Yes |
| ISO 50001:2018 | No | No | No |
| UL 94V-0 | Yes | Yes | Yes |
| IATF 16949:2016 (Automoti | ve) Yes | Yes | Yes |
| ISO 13485 (Medical) | No | Yes | No |
| AS9100D | No | No | Yes |
| ISO 9001:2015 | Yes | Yes | Yes |
| ISO 14001:2015 | Yes | Yes | Yes |
| ISO 45001:2018 | No | Yes | Yes |
| TYYY | 0 0 | 000 | |